

## Excellent Integrated System Limited

Stocking Distributor

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[IXYS Corporation](#)

[DSEC30-06A](#)

For any questions, you can email us directly:

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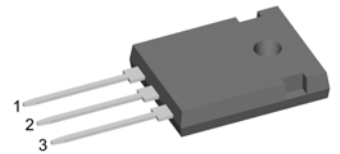
## HiPerFRED

$V_{RRM}$	=	600V
$I_{FAV}$	= 2x	15A
$t_{rr}$	=	35ns

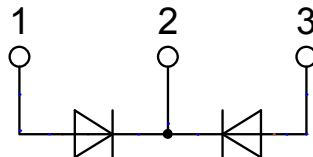
High Performance Fast Recovery Diode  
Low Loss and Soft Recovery  
Common Cathode

Part number

**DSEC30-06A**



Backside: cathode



### Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low  $I_{rm}$ -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low  $I_{rm}$  reduces:
  - Power dissipation within the diode
  - Turn-on loss in the commutating switch

### Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

### Package: TO-247

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

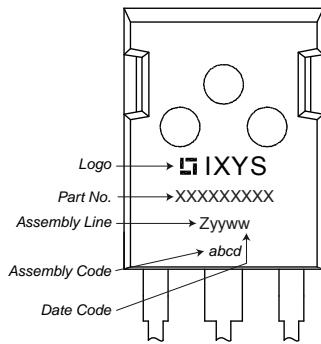
Fast Diode				Ratings		
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$V_{RSM}$	max. non-repetitive reverse blocking voltage				600	V
$V_{RRM}$	max. repetitive reverse blocking voltage				600	V
$I_R$	reverse current, drain current	$V_R = 600\text{ V}$	$T_{VJ} = 25^\circ\text{C}$		100	$\mu\text{A}$
		$V_R = 600\text{ V}$	$T_{VJ} = 150^\circ\text{C}$		0.5	mA
$V_F$	forward voltage drop	$I_F = 15\text{ A}$	$T_{VJ} = 25^\circ\text{C}$		2.03	V
					2.24	V
		$I_F = 30\text{ A}$	$T_{VJ} = 150^\circ\text{C}$		1.34	V
					1.57	V
$I_{FAV}$	average forward current	$T_C = 140^\circ\text{C}$ rectangular $d = 0.5$	$T_{VJ} = 175^\circ\text{C}$		15	A
$V_{F0}$	threshold voltage	} for power loss calculation only	$T_{VJ} = 175^\circ\text{C}$		0.99	V
$r_F$	slope resistance				14.3	m $\Omega$
$R_{thJC}$	thermal resistance junction to case				1.6	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.25		K/W
$P_{tot}$	total power dissipation		$T_C = 25^\circ\text{C}$		95	W
$I_{FSM}$	max. forward surge current	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}; V_R = 0\text{ V}$	$T_{VJ} = 45^\circ\text{C}$		110	A
$C_J$	junction capacitance	$V_R = 400\text{ V}$ $f = 1\text{ MHz}$	$T_{VJ} = 25^\circ\text{C}$		12	pF
$I_{RM}$	max. reverse recovery current	} $I_F = 15\text{ A}; V_R = 300\text{ V}$ $-di_F/dt = 200\text{ A}/\mu\text{s}$	$T_{VJ} = 25^\circ\text{C}$		5	A
$t_{rr}$	reverse recovery time		$T_{VJ} = 100^\circ\text{C}$		7	A
			$T_{VJ} = 25^\circ\text{C}$		35	ns
		$T_{VJ} = 100^\circ\text{C}$		95	ns	
$E_{AS}$	non-repetitive avalanche energy	$I_{AS} = 1\text{ A}$ $L = 180\text{ }\mu\text{H}$	$T_{VJ} = 25^\circ\text{C}$		0.1	mJ
$I_{AR}$	repetitive avalanche current	$V_A = 1.5 \cdot V_R$ typ.: $f = 10\text{ kHz}$			0.1	A



## DSEC30-06A

Package TO-247			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$I_{RMS}$	RMS current	per terminal <sup>1)</sup>			50	A
$T_{VJ}$	virtual junction temperature		-55		175	°C
$T_{op}$	operation temperature		-55		150	°C
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				6		g
$M_D$	mounting torque		0.8		1.2	Nm
$F_C$	mounting force with clip		20		120	N

### Product Marking



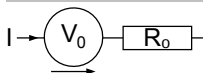
Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DSEC30-06A	DSEC30-06A	Tube	30	473502

Similar Part	Package	Voltage class
DSEC30-06B	TO-247AD (3)	600
DSEC29-06AC	ISOPLUS220AB (3)	600

### Equivalent Circuits for Simulation

\* on die level

$T_{VJ} = 175\text{ °C}$



**Fast Diode**

$V_{0\ max}$  threshold voltage

0.99

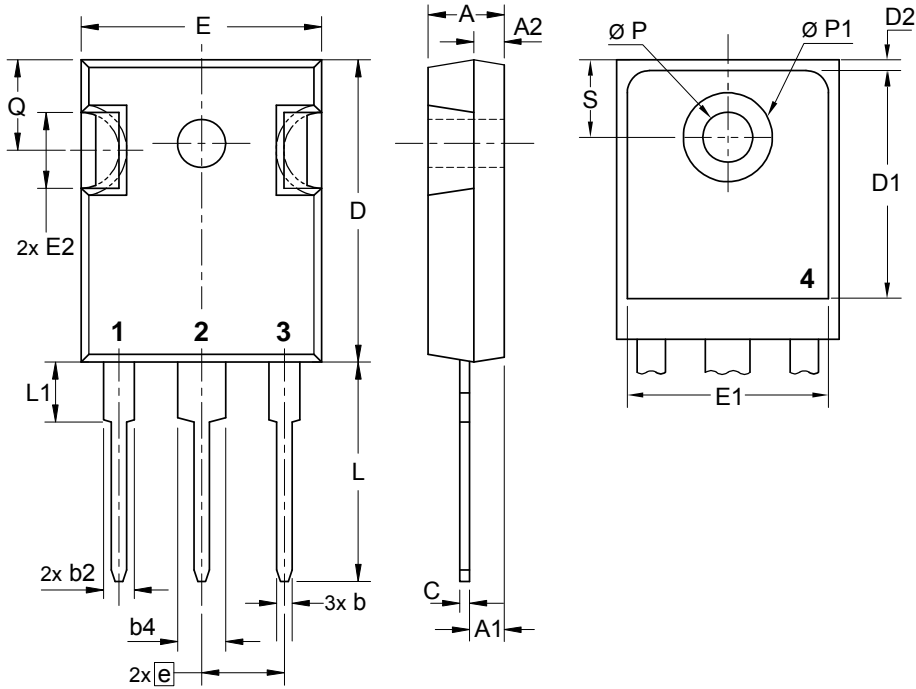
V

$R_{0\ max}$  slope resistance \*

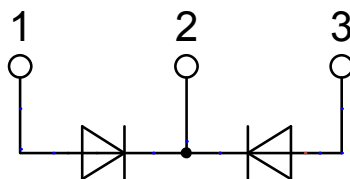
11.7

mΩ

**Outlines TO-247**



Sym.	Inches		Millimeter	
	min.	max.	min.	max.
A	0.185	0.209	4.70	5.30
A1	0.087	0.102	2.21	2.59
A2	0.059	0.098	1.50	2.49
D	0.819	0.845	20.79	21.45
E	0.610	0.640	15.48	16.24
E2	0.170	0.216	4.31	5.48
e	0.215 BSC		5.46 BSC	
L	0.780	0.800	19.80	20.30
L1	-	0.177	-	4.49
Ø P	0.140	0.144	3.55	3.65
Q	0.212	0.244	5.38	6.19
S	0.242 BSC		6.14 BSC	
b	0.039	0.055	0.99	1.40
b2	0.065	0.094	1.65	2.39
b4	0.102	0.135	2.59	3.43
c	0.015	0.035	0.38	0.89
D1	0.515	-	13.07	-
D2	0.020	0.053	0.51	1.35
E1	0.530	-	13.45	-
Ø P1	-	0.29	-	7.39



**Fast Diode**

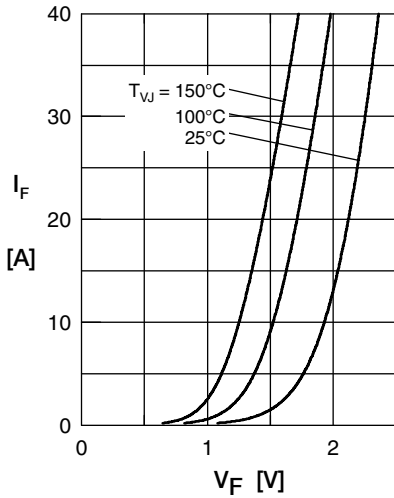


Fig. 1 Forward current  $I_F$  versus  $V_F$

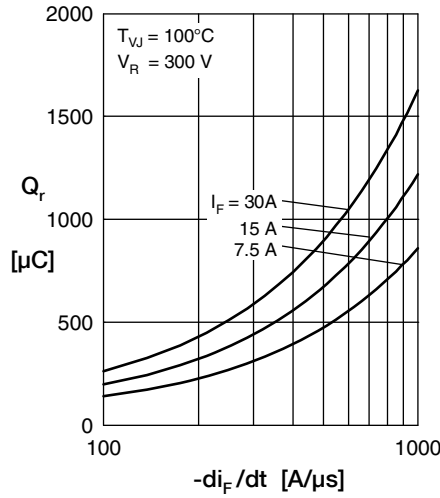


Fig. 2 Typ. reverse recov. charge  $Q_r$  versus  $-di_F/dt$

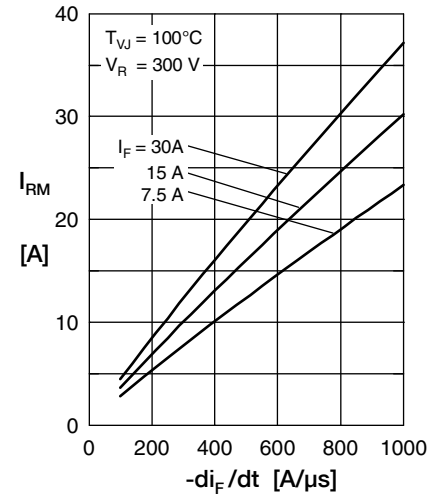


Fig. 3 Typ. peak reverse current  $I_{RM}$  versus  $-di_F/dt$

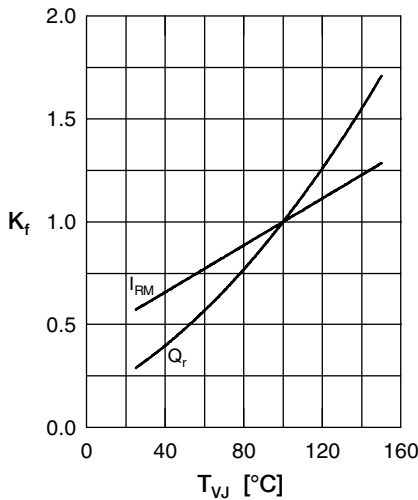


Fig. 4 Dynamic parameters  $Q_r$ ,  $I_{RM}$  versus  $T_{VJ}$

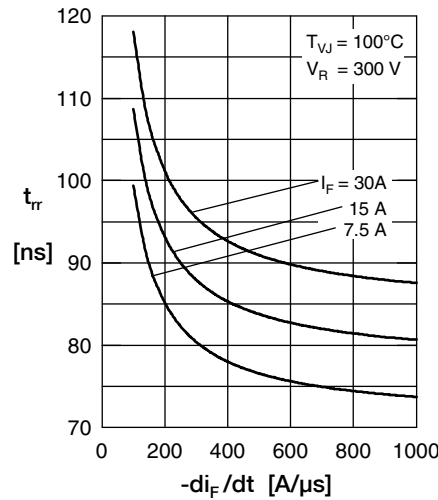


Fig. 5 Typ. recovery time  $t_{rr}$  versus  $-di_F/dt$

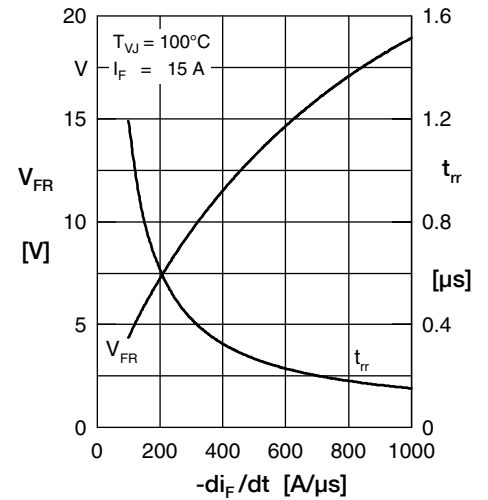


Fig. 6 Typ. peak forward voltage  $V_{FR}$  and  $t_{rr}$  versus  $di_F/dt$

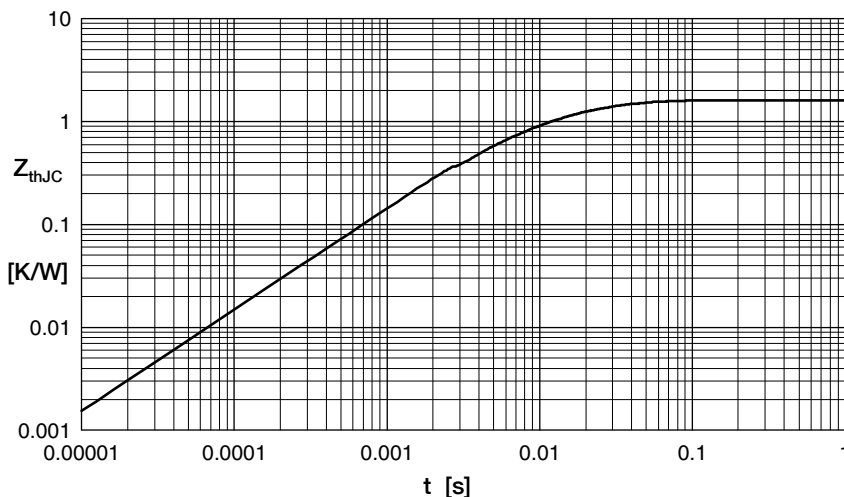


Fig. 7 Transient thermal impedance junction to case

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.908	0.0052
2	0.350	0.0003
3	0.342	0.017